

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1418	(semiconductor and alignment and pad\$1 and position\$1 and camera)	USPAT	OR	OFF	2005/09/02 15:41
S2	3	(semiconductor and alignment and pad\$1 and position\$1 and camera).clm.	USPAT	OR	OFF	2005/09/02 15:42
S3	4	324/770 and (semiconductor and alignment and pad\$1 and position\$1 and camera)	USPAT	OR	OFF	2005/09/02 16:18
S4	536	(semiconductor and alignment and pad\$1 and position\$1 and camera and identify\$3)	USPAT	OR	OFF	2005/09/02 16:18
S5	336	(semiconductor and alignment and pad\$1 and position\$1 and camera and identify\$3 and axis)	USPAT	OR	OFF	2005/09/02 16:18
S6	146	(semiconductor and alignment and pad\$1 and position\$1 and camera and identify\$3 and axis and signal\$1 and flexible)	USPAT	OR	OFF	2005/09/02 16:18
S7	134	(semiconductor and alignment and pad\$1 and position\$1 and camera and identify\$3 and axis and signal\$1 and flexible and interface)	USPAT	OR	OFF	2005/09/02 16:19
S8	5	"324"/\$.ccls. and (semiconductor and alignment and pad\$1 and position\$1 and camera and identify\$3 and axis and signal\$1 and flexible and interface)	USPAT	OR	OFF	2005/09/02 16:26
S9	10	"324"/755 and (semiconductor and alignment and pad\$1 and position\$1 and camera and identify\$3 and axis)	USPAT	OR	OFF	2005/09/02 17:24
S10	16	"324"/754 and (semiconductor and alignment and pad\$1 and position\$1 and camera and identify\$3 and axis)	USPAT	OR	OFF	2005/09/02 17:24
S11	3	"324"/762 and (semiconductor and alignment and pad\$1 and position\$1 and camera and identify\$3 and axis)	USPAT	OR	OFF	2005/09/02 17:26
S12	10	"324"/158.1 and (semiconductor and alignment and pad\$1 and position\$1 and camera and identify\$3 and axis)	USPAT	OR	OFF	2005/09/07 13:42
S13	98	"5974662"	USPAT	OR	OFF	2005/09/07 14:58

S14	1232	(semiconductor\$1 and packag\$3 and carrier\$1 and socket\$1 and pad\$1)	USPAT	OR	OFF	2005/09/07 14:59
S15	445	(semiconductor\$1 and packag\$3 and carrier\$1 and socket\$1 and pad\$1 and wir\$3 and burn\$3)	USPAT	OR	OFF	2005/09/07 15:00
S16	361	(semiconductor\$1 and packag\$3 and carrier\$1 and socket\$1 and pad\$1 and wir\$3 and burn\$3 and test\$3 and lead\$1)	USPAT	OR	OFF	2005/09/07 15:00
S17	59	(semiconductor\$1 and packag\$3 and carrier\$1 and socket\$1 and pad\$1 and wir\$3 and burn\$3 and test\$3 and lead\$1 and chip\$1 and reduction)	USPAT	OR	OFF	2005/09/07 15:06
S18	0	(semiconductor\$1 and packag\$3 and carrier\$1 and socket\$1 and pad\$1 and wir\$3 and burn\$3 and test\$3 and lead\$1 and chip\$1 and reduction).clm.	USPAT	OR	OFF	2005/09/07 15:07
S19	1	(semiconductor\$1 and packag\$3 and carrier\$1 and socket\$1 and pad\$1 and wir\$3 and burn\$3 and test\$3).clm.	USPAT	OR	OFF	2005/09/07 15:07
S20	2	(semiconductor\$1 and packag\$3 and carrier\$1 and socket\$1 and pad\$1 and wir\$3 and test\$3).clm.	USPAT	OR	OFF	2005/09/07 15:07
S21	81458	(semiconductor\$1 and packag\$3 and carrier\$1 and socket\$1 and pad\$1 and test\$3).clm.	USPAT	OR	OFF	2005/09/07 15:07
S22	7	(semiconductor\$1 and packag\$3 and carrier\$1 and socket\$1 and pad\$1 and test\$3).clm.	USPAT	OR	OFF	2005/09/07 15:08
S23	19	(semiconductor\$1 and packag\$3 and carrier\$1 and socket\$1 and test\$3).clm.	USPAT	OR	OFF	2005/09/07 15:09
S24	25	(semiconductor\$1 and carrier\$1 same socket\$1 and test\$3).clm.	USPAT	OR	OFF	2005/09/07 15:13
S25	47	(semiconductor\$1 same socket\$1 and test\$3 and chip\$1).clm.	USPAT	OR	OFF	2005/09/13 10:56
S26	3	"6504389"	USPAT	OR	OFF	2005/09/13 10:56